Microgravity Science Division Space Directorate

Capillary Surface Dynamics and Solidification: Application to Solder Jetting

- Commercial application precision dispensing of liquid metal solder for microelectronic component fabrication
- Low gravity experiments enables quantitative measurement of impact dynamics due to increased droplet size.
 Dynamic similarity principles allow extrapolation to (smaller) practical length scales
- Collaboration between MicroFab Technologies, Motorola and NASA funded investigators at the University of Illinois at Chicago and NCMR





